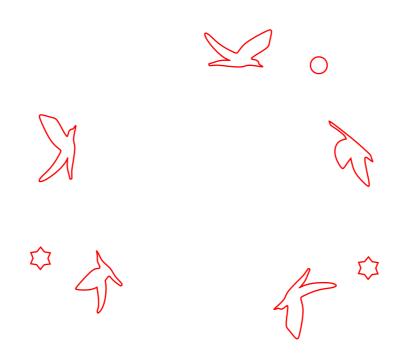
## PLACE BASE AREAMINE HESIGHTO PARAME LASER CUTTER PLACE A SHEET OF 0.023MM CELLOPHANE IN THE LASER CUTTER

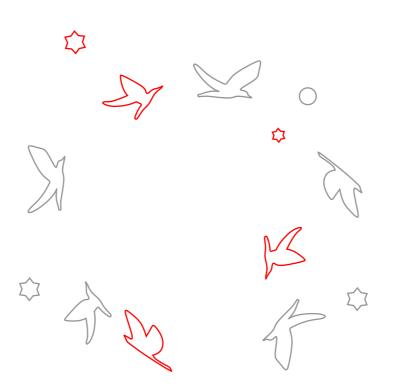


POWER: 12.5%

SPEED: 3%

LASER Z: 0.023 MM

# CUTTING PASS # 2 PLACE28982340RME16H89E23MNN THE LASER CUTTER PLACE A SHEET OF 0.03MM CELLOPHANE IN THE LASER CUTTER

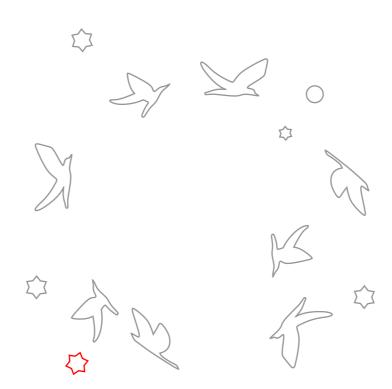


POWER: 12.5%

SPEED: 3%

LASER Z: 0.03 MM

## PLACE BASE ACAPMENT CHESTAGE PLACE A SHEET OF 0.045MM CELLOPHANE IN THE LASER CUTTER

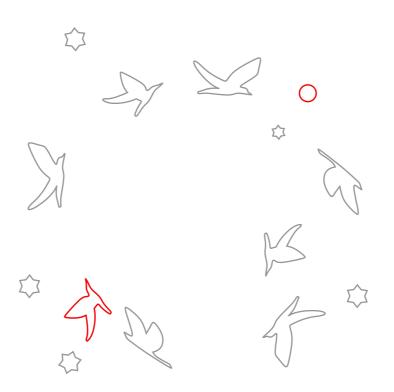


POWER: 12.5%

SPEED: 3%

LASER Z: 0.045 MM

# CUTTING PASS # 4 PLACE-BAGE3MMRMEIGH5AEQ46MM THE LASER CUTTER PLACE A SHEET OF 0.023MM CELLOPHANE IN THE LASER CUTTER

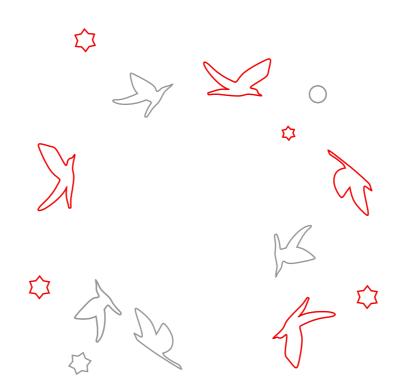


POWER: 12.5%

SPEED: 3%

LASER Z: 0.046 MM

## PLACE BASE AND MINITER HELD PHANE LASER CUTTER PLACE A SHEET OF 0.035MM CELLOPHANE IN THE LASER CUTTER

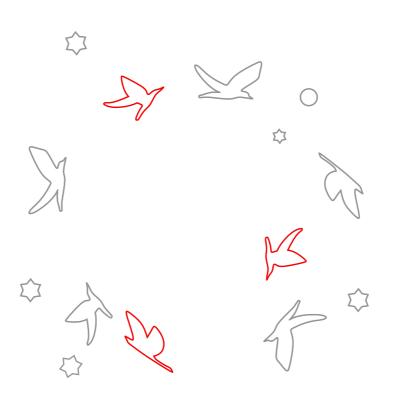


POWER: 12.5%

SPEED: 3%

LASER Z: 0.058 MM

# CUTTING PASS # 6 PLACE BASE ACTOY-LOISON B-HEETGHTN -TARM LASER CUTTER PLACE A SHEET OF 0.03MM CELLOPHANE IN THE LASER CUTTER

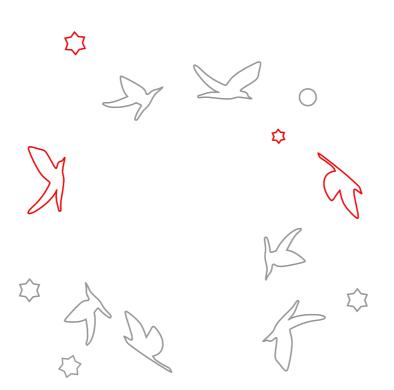


POWER: 12.5%

SPEED: 3%

LASER Z: 0.06 MM

## PLACE BASE AND MINITER HELD IN THE LASER CUTTER PLACE A SHEET OF 0.035MM CELLOPHANE IN THE LASER CUTTER

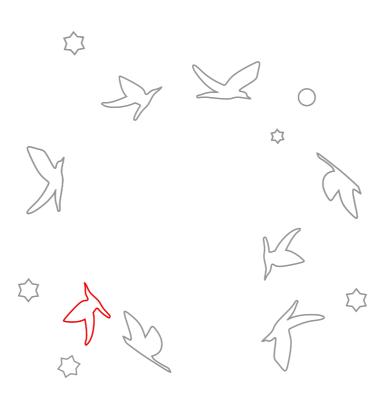


POWER: 12.5%

SPEED: 3%

LASER Z: 0.093 MM

## PLACE BASE A SHEET OF 0.053MM CELLOPHANE IN THE LASER CUTTER

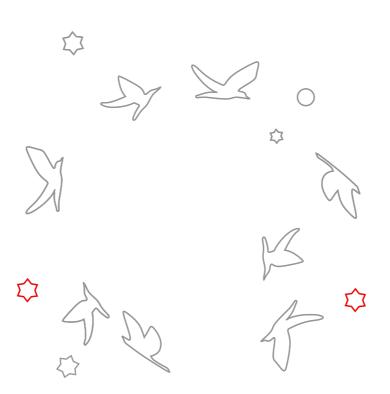


POWER: 12.5%

SPEED: 3%

LASER Z: 0.099 MM

## PLACE BASED A CAPMULTE SHEET P. IN IMME LASER CUTTER PLACE A SHEET OF 0.053MM CELLOPHANE IN THE LASER CUTTER

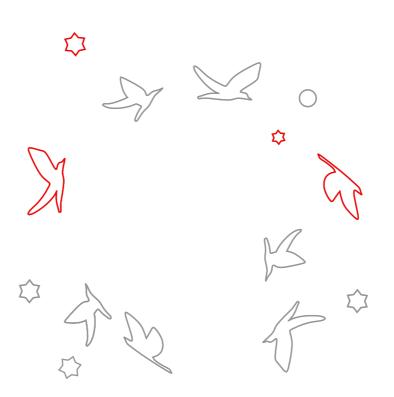


POWER: 12.5%

SPEED: 3%

LASER Z: 0.111 MM

# CUTTING PASS # 10 PLACE BASEO A OR PMYCHE HE HE HO IN 46 MM LASER CUTTER PLACE A SHEET OF 0.053MM CELLOPHANE IN THE LASER CUTTER

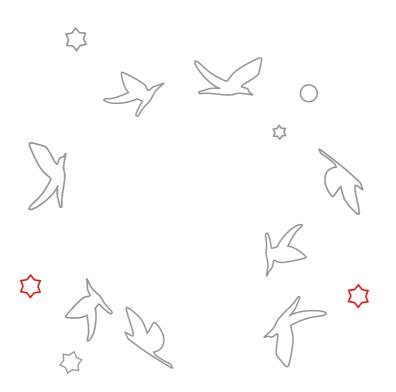


POWER: 12.5%

SPEED: 3%

LASER Z: 0.146 MM

# CUTTING PASS # 11 PLACE BASE 1 A CRY 2 5 2 M M H H E T G H NO T H E 4 M M SER CUTTER PLACE A SHEET OF 0.053MM CELLOPHANE IN THE LASER CUTTER



POWER: 12.5%

SPEED: 3%

LASER Z: 0.164 MM